506341722 11/06/2020

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HIROMICHI YAMASHITA	10/30/2020

RECEIVING PARTY DATA

Name:	HITACHI HIGH-TECH CORPORATION	
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City:	TOKYO	
State/Country:	JAPAN	
Postal Code:	105-6409	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16980455

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	KAI-12805
NAME OF SUBMITTER:	JOHN MATTINGLY
SIGNATURE:	/John Mattingly/
DATE SIGNED:	11/06/2020

Total Attachments: 1

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PATENT REEL: 054294 FRAME: 0403

ASSIGNMENT (譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI HIGH-TECH CORPORATION, a corporation organized under the laws of Japan,

located at 17-1, Toranomon 1-chome, Minato-ku, Tokyo 105-6409 Japan receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI HIGH-TECH CORPORATION.

its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said HITACHI HIGH-TECH CORPORATION,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference preceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI HIGH-TECH CORPORATION.

Signed on the date(s) indicated aside our signatures:

	NVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1)	Hiromichi Yumashita Hiromichi YAMASHITA	10/30/2020
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RECORDED: 11/06/2020